



25x32MM Daisy-Chain PBGA

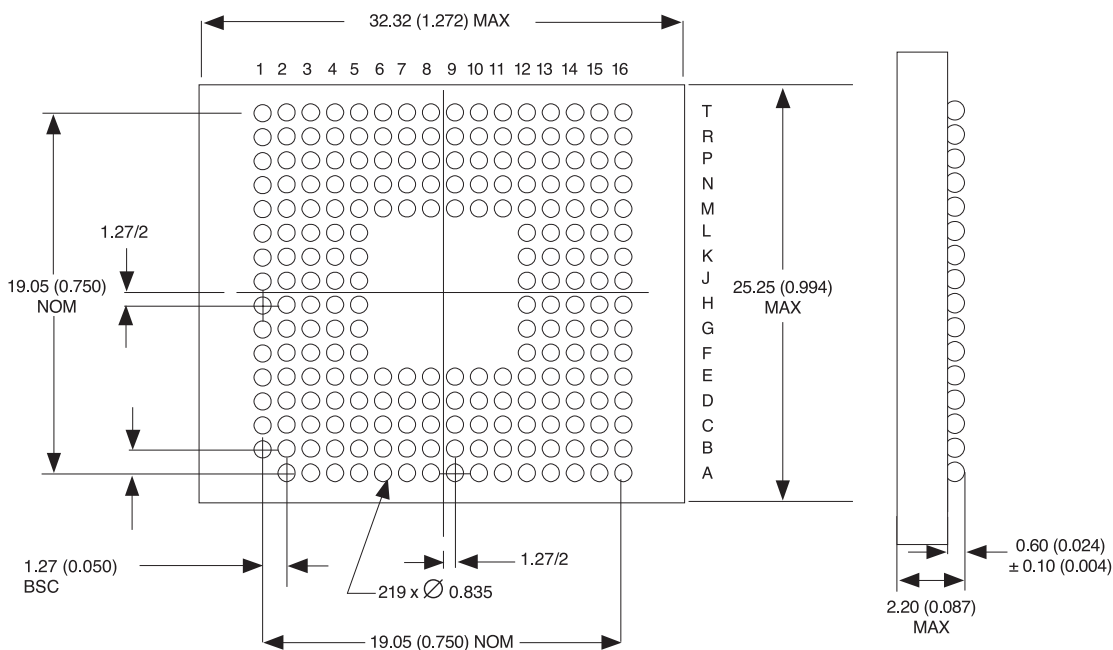
FEATURES REPRESENTATIVE OF WEDC PBGAS:

- 25 x 32mm, 25 x 25mm, 25 x 21mm, 21 x 21mm
- Package material and assembly process
- Ball pads diameter and ball attach process
- Substrate dimensions, material, process and thickness (no vias)
- Die dimensions and thickness (dummy die, no wirebonds) 3 - State Outputs

DESCRIPTION

This is a mechanical daisy-chain test vehicle designed to be representative of the 25 x 32mm, 25 x 25mm, 25 x 21mm, and 21 x 21mm packages. Use is for second level interconnection assembly test such temperature cycling, and continuity verification of the PBGA to the test board when it is overflowed.

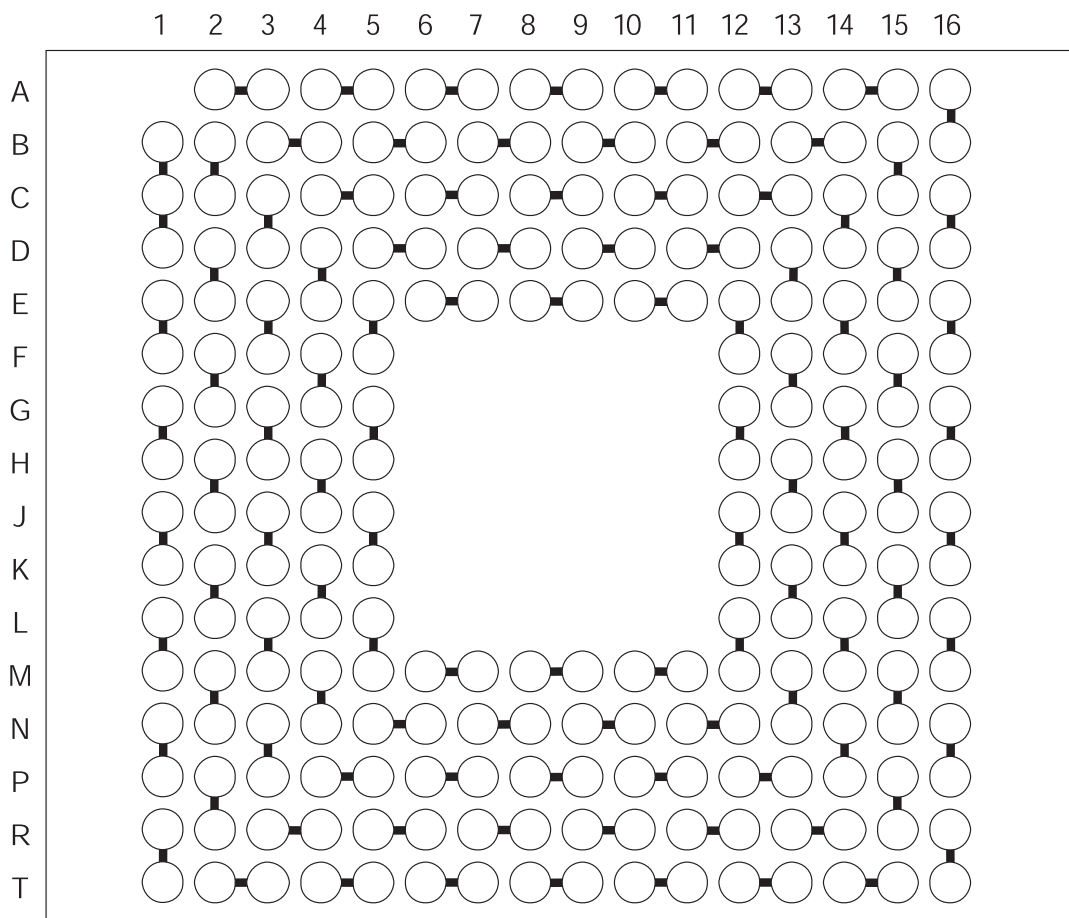
PACKAGE DIMENSION: 219 PLASTIC BALL GRID ARRAY (PBGA)



all linear dimensions are in millimeters and parenthetically in inches



FIG. 1: DAISY-CHAIN INTERCONNECTION





ORDERING INFORMATION

WEP P DC 3225 B

PACKAGE:

B = 219 PBGA

PACKAGE DIMENSIONS:

3225 = 32mm x 25mm

TYPE:

DC = DAISY CHAIN

PLASTIC

WHITE ELECTRONIC DESIGNS CORP.